

#### **Description**

The 4N65F can be used in various power swithching circuit for system miniaturization and higher efficiency. The package form is TO-220/TO-220F, which accords with the RoHS standard.

#### **General Features**

 $V_{DS} = 650V, I_D = 20A$  $R_{DS(ON)} < 0.3 \Omega@V_{GS} = 10V$ 

# TO-220F (TO-220F-3) PIN2 D PIN3 S

#### N-Channel MOSFET

#### **Application**

• Power switch circuit of adaptor and charger.

### **Package Marking and Ordering Information**

Product ID	Pack	Marking	Units Tube
4N65F	TO-220F(TO-220F-3)	4N65 XXX YYYY	50

#### Absolute Maximum Ratings@T =25°C(unless otherwise specified)

Symbol	Parameter	Limit	Unit	
V <sub>DSS</sub>	Drain-to-Source Voltage <sup>[1]</sup>	650	V	
V <sub>GSS</sub>	Gate-to-Source Voltage	±30		
I <sub>D</sub>	Continuous Drain Current	4		
I <sub>D @ Tc =100</sub> ℃	Continuous Drain Current @ Tc=100℃	3	Α	
I <sub>DM</sub>	Pulsed Drain Current at V <sub>GS</sub> =10V <sup>[2]</sup>	16		
E <sub>AS</sub>	Single Pulse Avalanche Energy	125	mJ	
P <sub>D</sub>	Power Dissipation	27	W	
T <sub>L</sub> T <sub>PAK</sub>	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds	300 260	°C	
T <sub>J</sub> & T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 150		
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	4.7	°C 111	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°CM	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.



## Electrical Characteristics T<sub>J</sub> =25°C unless otherwise specified

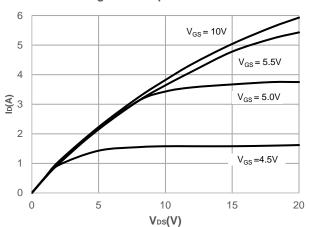
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	650	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R <sub>DS(ON)</sub>	Static Drain-Source ON-Resistance <sup>(4)</sup>	$V_{GS} = 10V, I_D = 2A$	-	2.22	2.64	Ω
C <sub>iss</sub>	Input Capacitance	V 0V V 07V	-	587	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{GS} = 0V$ , $V_{DS} = 25V$ , f = 1MHz	-	59	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1141112	-	10	-	pF
$Q_g$	Total Gate Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 520V, I_{D} = 4A$	-	15	-	nC
$Q_{gs}$	Gate Source Charge		-	3.5	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	· · · · · · · · · · · · · · · · · · ·	-	6	-	nC
t <sub>d(on)</sub>	Turn-On DelayTime	$V_{GS} = 10V, V_{DD} = 320V$ $I_{D} = 4A, R_{GEN} = 24\Omega$	-	13	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	22	-	ns
t <sub>d(off)</sub>	Turn-Off DelayTime		-	43	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	27	-	ns
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	4	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	16	А
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 4A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 40 41/44 4000/	-	280	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 4A$ , di/dt = 100A/us	-	2	-	μC

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- 2. E\_{AS} condition: Starting T\_J=25C, V\_DD=50V, V\_G=10V, R\_G=25ohm, L=10mH, I\_{AS}=5A
- 3.  $R_{\theta JA}$  is measured with the device mounted on a minimum recommended pad of 2oz copper FR4 PCB
- 4. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  0.5%.

# **Typical Characteristics**

Figure 1: Output Characteristics



**Figure 2: Typical Transfer Characteristics** 

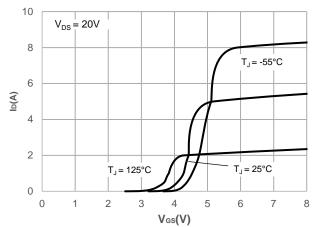


Figure 3: On-resistance vs. Drain Current

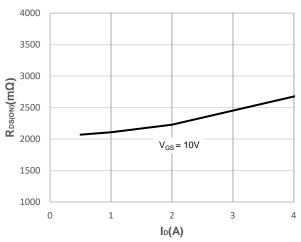


Figure 4: Body Diode Characteristics

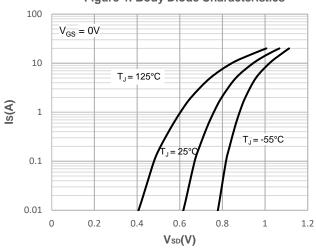


Figure 5: Gate Charge Characteristics

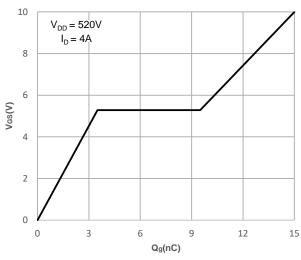


Figure 6: Capacitance Characteristics

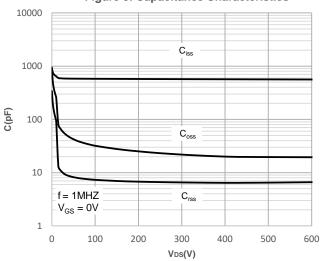


Figure 7: Normalized Breakdown voltage vs. **Junction Temperature** 

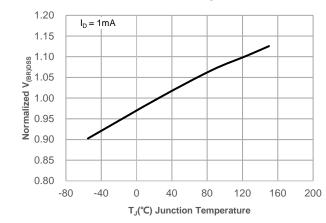
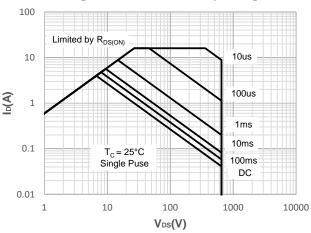


Figure 9: Maximum Safe Operating Area



**Figure 11: Normalized Maximum Transient** Thermal Impedance

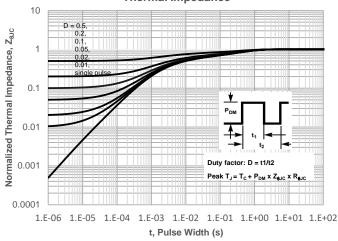


Figure 8: Normalized on Resistance vs. **Junction Temperature** 

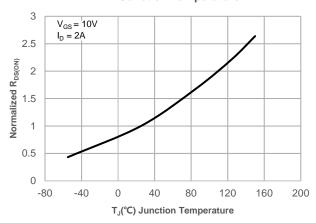


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

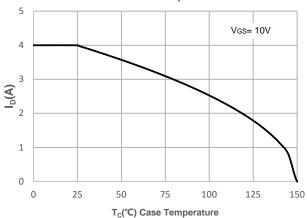
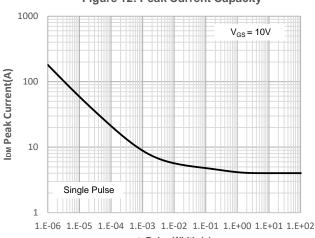


Figure 12: Peak Current Capacity



t, Pulse Width (s)

#### **Test Circuit**

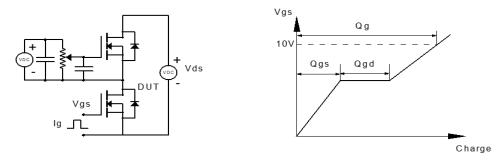


Figure 1: Gate Charge Test Circuit & Waveform

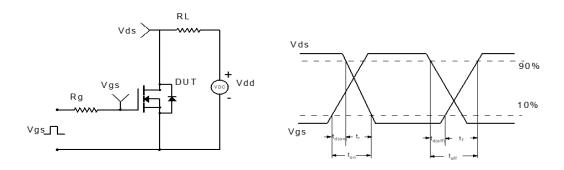


Figure 2: Resistive Switching Test Circuit & Waveform

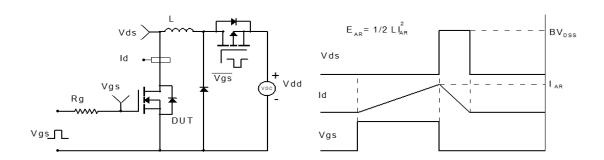


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

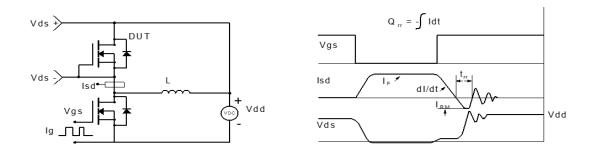
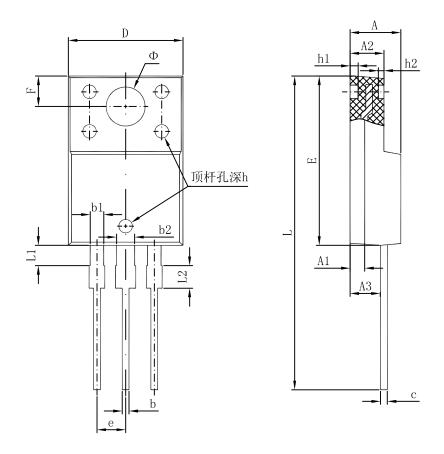


Figure 4: Diode Recovery Test Circuit & Waveform

# Package Dimension TO-220F(TO-220F-3)



Comple ed	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.300	4.700	0.169	0.185	
A1	1.300	1.300 REF.		REF.	
A2	2.800	3.200	0.110	0.126	
A3	2.500	2.900	0.098	0.114	
b	0.500	0.750	0.020	0.030	
b1	1.100	1.350	0.043	0.053	
b2	1.500	1.750	0.059	0.069	
С	0.500	0.750	0.020	0.030	
D	9.960	10.360	0.392	0.408	
Е	14.800	15.200	0.583	0.598	
е	2.540 TYP.		0.100 TYP.		
F	2.700	REF.	0.106 REF.		
Ф	3.500	REF.	0.138 REF.		
h	0.000	0.300	0.000	0.012	
h1	0.800 REF.		0.031 REF.		
h2	0.500 REF.		0.020 REF.		
L	28.000	28.400	1.102	1.118	
L1	1.700	1.900	0.067	0.075	
L2	1.900	2.100	0.075	0.083	



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